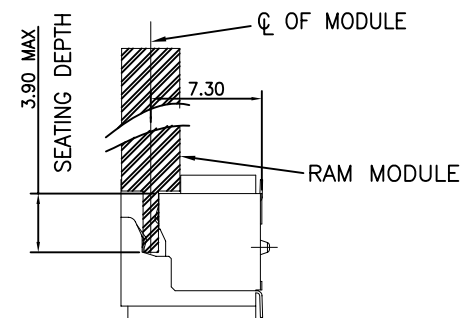
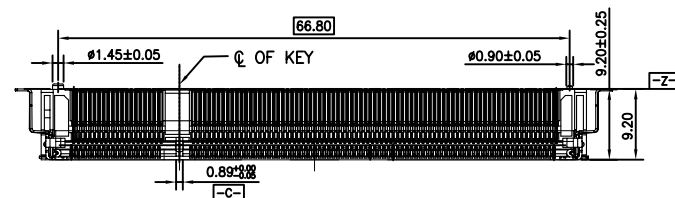
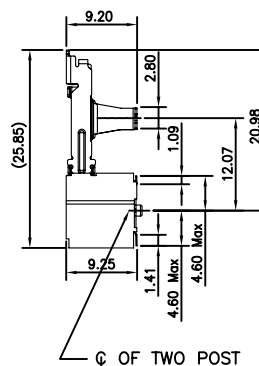
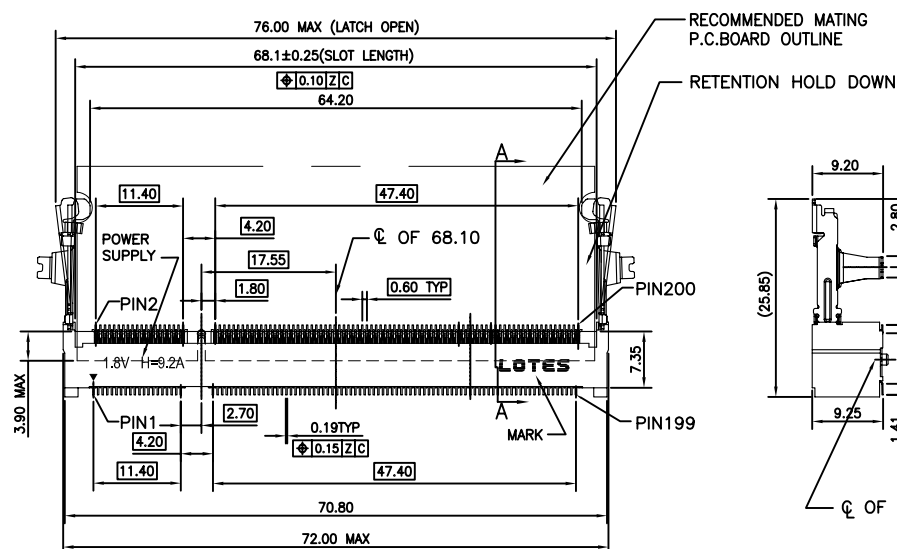


REV.	ECN NO./DESCRIPTION	DATE
1	N100069	03/08'2010
2	N100134	04/23'2010



SECTION A-A
SCALE 2:1



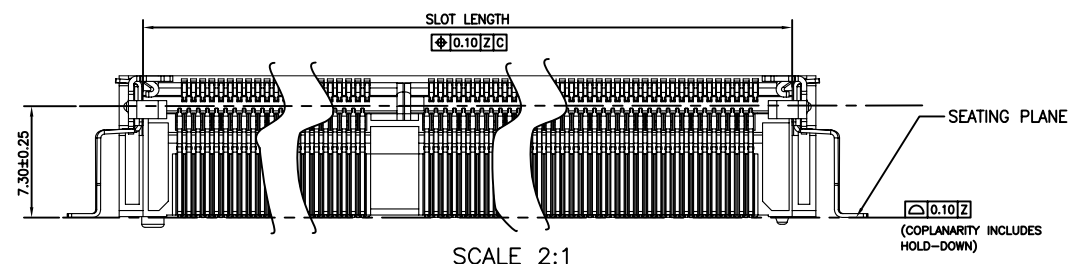
NOTES:

- MATERIAL SPECIFICATION,
 - 1-HOUSING:HIGH TEMPERATURE THERMO PLASTIC,UL94_V0
COLOR:BLACK OR WHITE
 - 1-2.CONTACTS:COPPER ALLOY
 - 1-3.STATOR:STAINLESS STEEL.
 - 1-4.LATCH:STAINLESS STEEL
- PLATING SPECIFICATION,
CONTACT:GOLD PLATED Min IN CONTACT AREA(SEE TABLE).
TIN(MATTE) OR GOLD PLATED Min IN SOLDERPNG AREA,
NICKEL UNDERPLATING ALL OVER.
STATOR:TIN(MATTE) OVER,NICKEL UNDERPLATING ALL OVER.
- AAA-DDR-115-P**:HF COMPLIANT
AAA-DDR-115-K**:RoHS COMPLIANT

TABLE:

NO.	PART NO.	PLATING	HOUSING	PACKAGE	VOLTAGE
4	AAA-DDR-115-P04	Contact Area: Au15u", Solder tail: G/F	Black	REEL	1.8V
3	AAA-DDR-115-P03	Contact Area: Au30u", Solder tail: Sn	Black	REEL	1.8V
2	AAA-DDR-115-P02	Contact Area: Au15u", Solder tail: Sn	Black	REEL	1.8V
1	AAA-DDR-115-K01	Contact Area: G/F, Solder tail: Sn	Black	REEL	1.8V

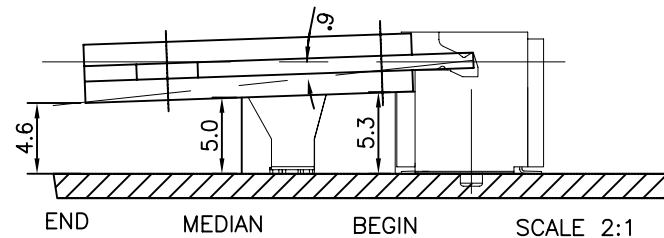
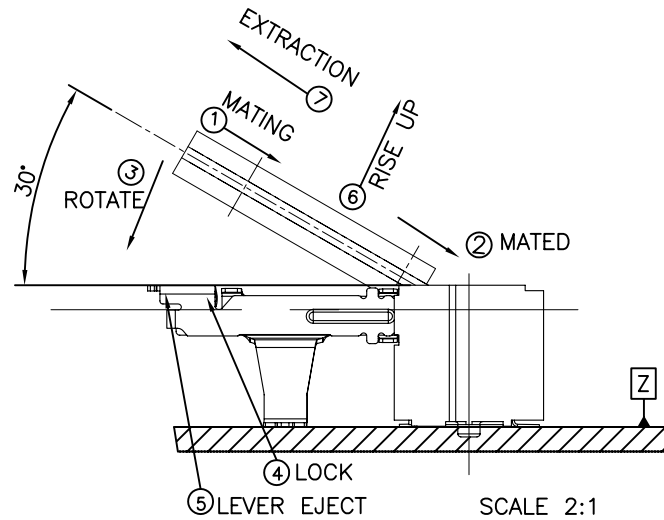
GENERAL TOLERANCES UNLESS SPECIFIED		PART NO.	LOTES		
.X ± 0.35	X° ± 3°	SEE TABLE			
.XX ± 0.25	X° ± 2°	APPROVED BY	TITLE		
.XXX ± 0.15	.XX° ± 1°	Smrk	SO.DDR2 9.2H A CONN.		
CUSTOMER DRAWING		CHECKED BY	DWG NO.		
		Joe	GAP-AAA-DDR-115		
SIZE	UNITS	DRAWN BY	SHEET	SCALE	REV
A4	MM[INCH]	JACK LIU 04/23'2010			



SCALE 2:1

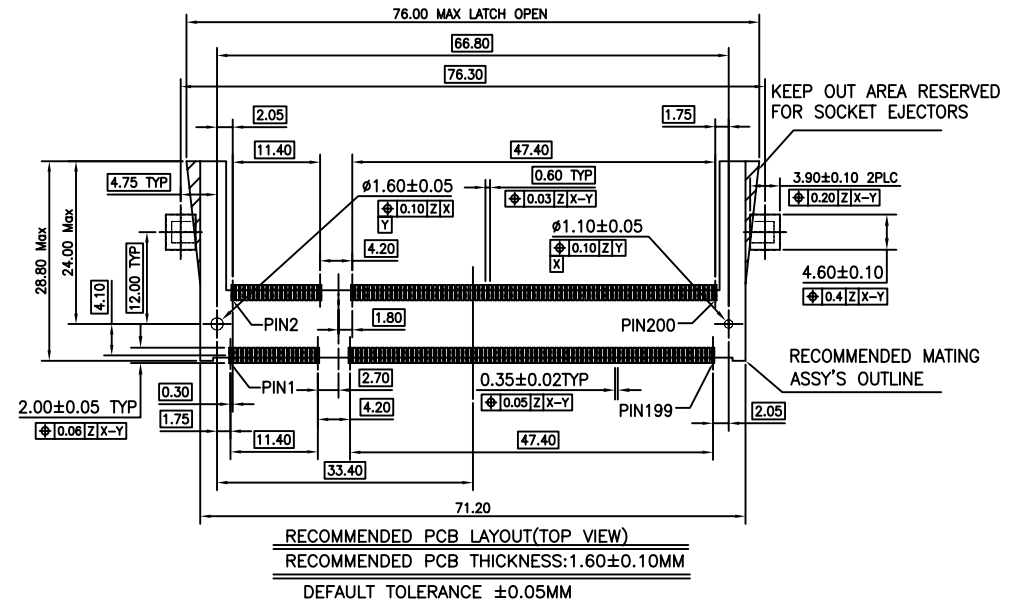
0.10 Z/C
(COPLANARITY INCLUDES
HOLD-DOWN)

REV.	ECN NO./DESCRIPTION	DATE
1	N100069	03/08/2010
2	N100134	04/23/2010



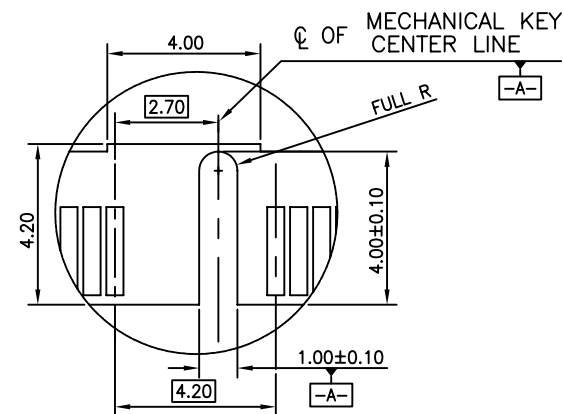
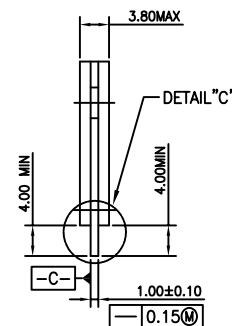
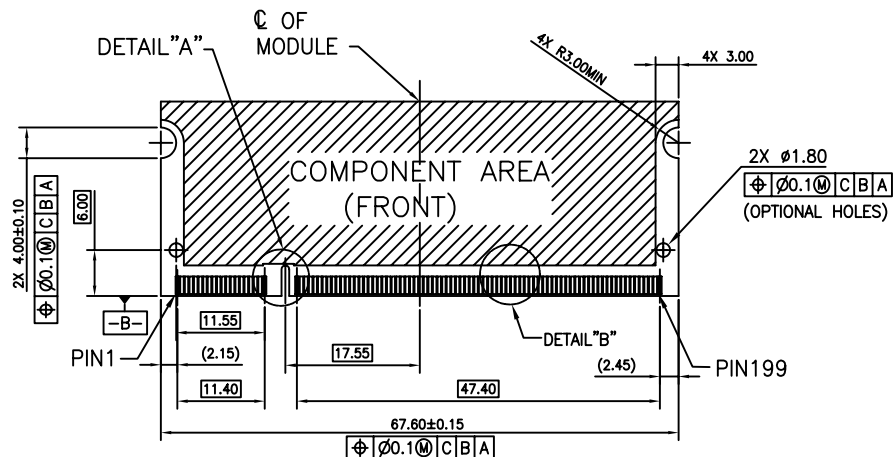
2° MAX. MODULE OVERLOAD ANGLE TO ENGAGE LATCH.
MAXIMUM RECOMMENDED COMPONENT HEIGHT ALLOWED ON MOTHERBOARD.

Max. Moudule Height=25.55mm		
END	MEDIAN	BEGIN
4.60	5.00	5.30



GENERAL TOLERANCES UNLESS SPECIFIED			PART NO.		LOTES			
.X± 0.35 .X°± 3°			SEE TABLE					
.XX± 0.25 .X°± 2°			APPROVED BY		TITLE SO.DDR2 9.2H A CONN.			
.XXX± 0.15 .XX°± 1°			Smark					
CUSTOMER DRAWING			CHECKED BY Joe		DWG NO. GAP-AAA-DDR-115			
SIZE	UNITS		DRAWN BY			SHEET	SCALE	REV
A4	MM[INCH]		JACK LIU 04/23'2010			2 / 4	1:1	2

REV.	ECN NO./DESCRIPTION	DATE
1	N100069	03/08'2010
2	N100134	04/23'2010

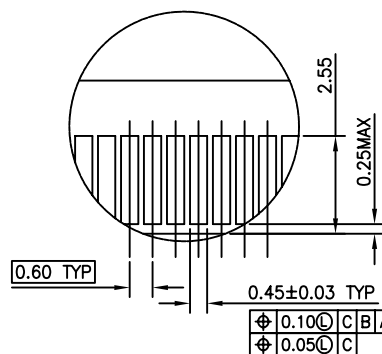
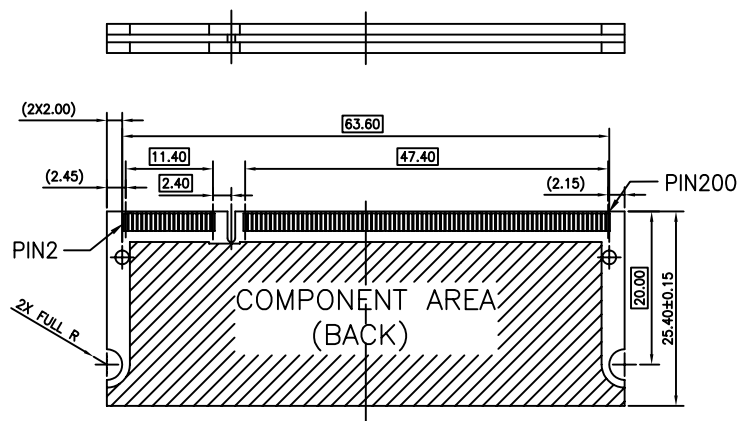


DETAIL A
SCALE 5:1

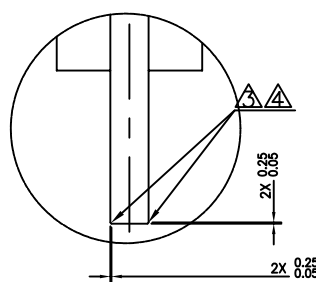
RECOMMENDED MATING P.C.B CONFIGURATION
RECOMMENDED P.C.B THICKNESS:1.00±0.05MM
DEFAULT TOLERANCE ±0.05MM

NOTES:

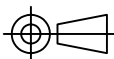
- 1.PCB THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALIZATION;
- 2.FINISH OF PAD: Au PLATING 0.76um min, OVER Ni PLATING 2um min;
- △NO BURR;
- △CHAMFER 0.25mm MAX. X 45° IF EXIST.



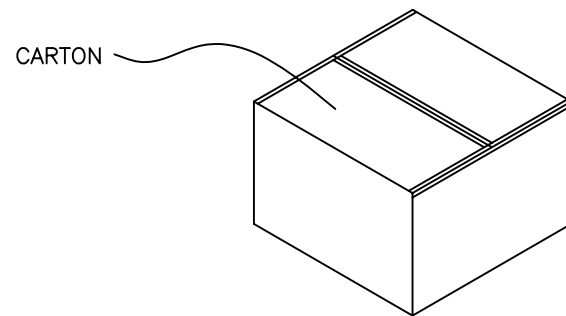
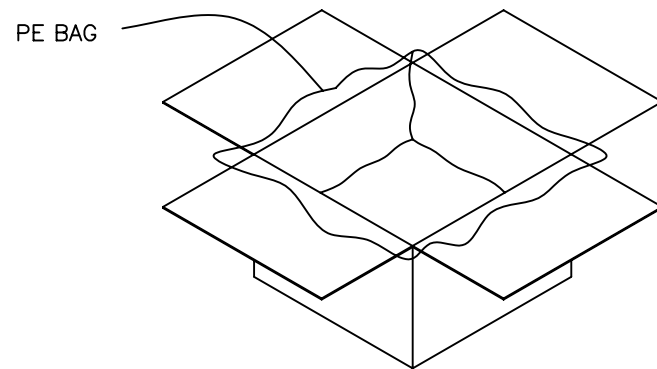
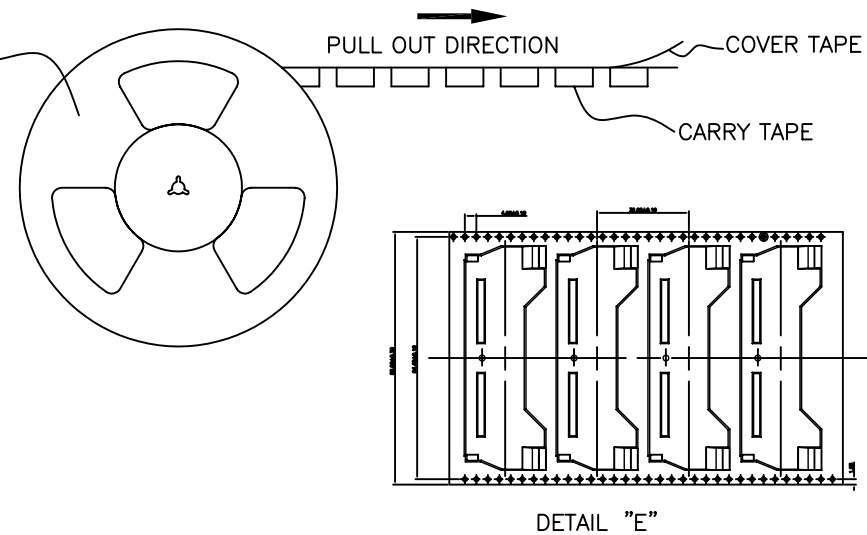
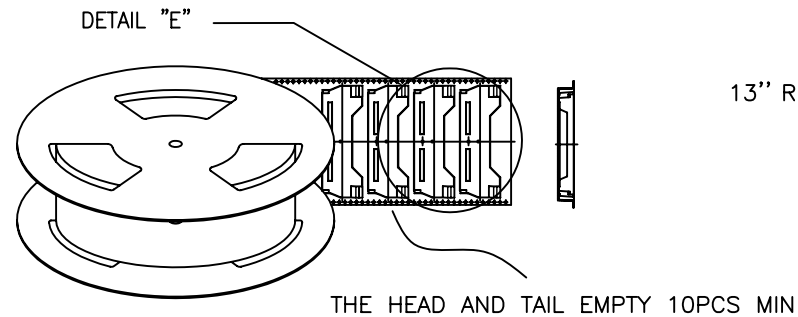
DETAIL B
SCALE 5:1



DETAIL "C"
SCALE 5:1

GENERAL TOLERANCES UNLESS SPECIFIED			PART NO.		LOTES			
.X ± 0.35		.X° ± 3°	SEE TABLE					
.XX ± 0.25		.X° ± 2°	APPROVED BY		TITLE			
.XXX ± 0.15		.XX° ± 1°	Smark		SO.DDR2 9.2H A CONN.			
CUSTOMER DRAWING			CHECKED BY		DWG NO.			
			Joe		GAP-AAA-DDR-115			
SIZE	UNITS	DRAWN BY				SHEET	SCALE	REV
A4	MM[INCH]	JACK LIU 04/23'2010				3 / 4	1:1	2

REV.	ECN NO./DESCRIPTION	DATE
1	N100069	03/08'2010
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NOTES:

- 1.THE OPERATION OF PACKING REFER THE LEFT PROCESS.
- 2.PACKING LIST.

DESCRIPTION	P/N	SPECIFICATION	QT'Y
SODDR ASS'Y	SEE TABLE	9.2H REEL PACKING	300PCS
REEL	G09-4-30008-101	13"; W=88; PS_BLUE	3PCS
CARRIER TAPE	G09-6-00045-101	4.5*88 ESD PS_BLACK	11.52M
COVER TAPE	G09-5-00018-101	HOT JOINT W=82.4	11.52M
PE BAG	G09-6-50002-101	L520*W320*H460	1PCS
FOAM	G09-8-30002-102	L320*W320*H10	4PCS
CARTON	G09-1-30010-101	L335*W335*H300; B=C	1PCS
INSIDER CARTON			

GENERAL TOLERANCES UNLESS SPECIFIED		PART NO.	LOTES			
.X ± 0.35 .X.° ± 3°		SEE TABLE				
.XX ± 0.25 .X.° ± 2°		APPROVED BY	TITLE SO.DDR2 9.2H A CONN.			
.XXX ± 0.15 .XX° ± 1°		Smark				
CUSTOMER DRAWING		CHECKED BY Joe	DWG NO. GAP-AAA-DDR-115			
SIZE	UNITS	DRAWN BY		SHEET	SCALE	REV
A4	MM[INCH]	JACK LIU 04/23'2010		4 / 4	1:1	2